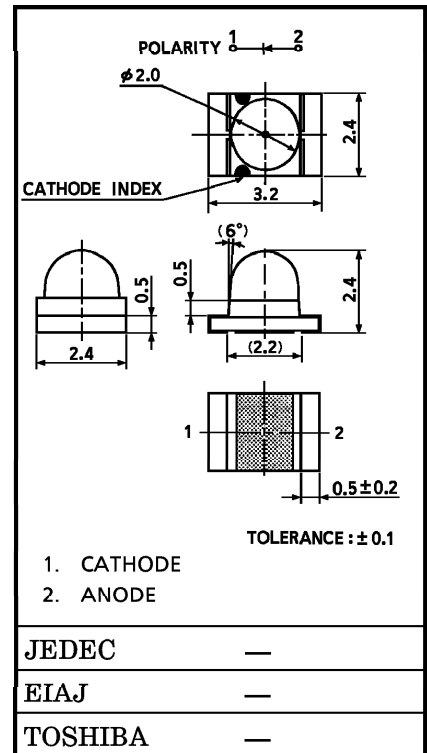


**TLS1005A (T03), TLG1005A (T03), TLPG1005A (T03)**

PANEL CIRCUIT INDICATOR

Unit in mm

- Surface Mount Device
- 3.2 (L) × 2.4 (W) × 2.4 (H) mm Size
- $\phi$ 2 mm Lens-top type
- Small Package - High Density Mounting is Available
- Colors : Red, Green, Pure Green
- Suitable Auto-mounting Machine Use
- Reflow Soldering is possible.
- Standard Embossed Taping  
4 mm Pitch : T03 (1000 pcs / Reel)
- Applications : Portable Equipment  
Message Signboards  
High Intensity Backlight  
Battery-Driven Equipment, etc.



Weight : 17 mg

LINE-UP

PRODUCT NAME	COLOR	MATERIAL
TLS1005A	Red	GaAsP
TLG1005A	Green	GaP
TLPG1005A	Pure-Green	GaP

961001EAC1

- TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.
- Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.

MAXIMUM RATINGS (Ta = 25°C)

PRODUCT NAME	FORWARD CURRENT (DC) $I_F$ (mA)	REVERSE VOLTAGE $V_R$ (V)	POWER DISSIPATION $P_D$ (mW)	OPERATING TEMPERATURE $T_{opr}$ (°C)	STORAGE TEMPERATURE $T_{stg}$ (°C)
TLS1005A	25	4	65.0	-25~80	-30~85
TLG1005A	25	4	62.5		
TLPG1005A	25	4	65.0		

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

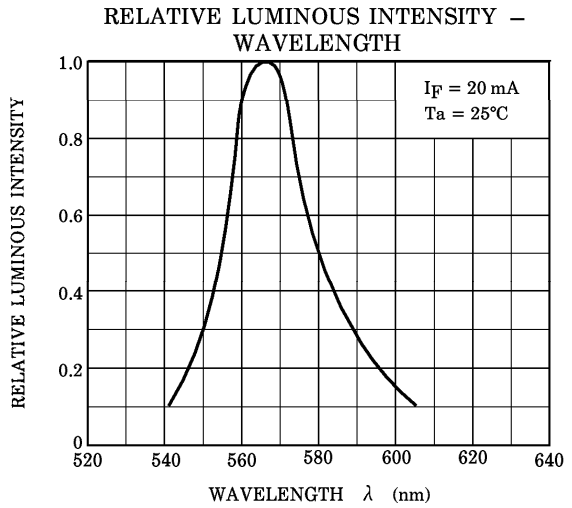
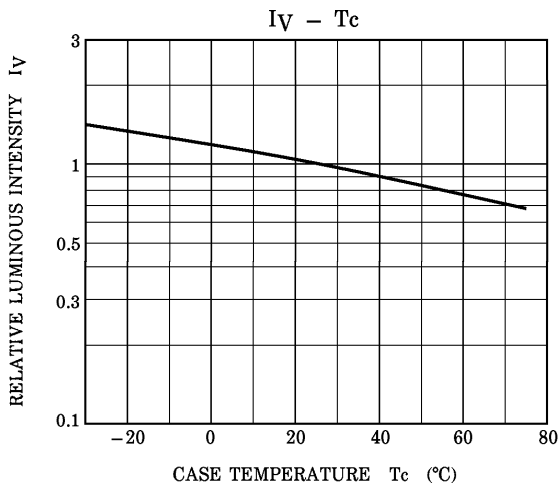
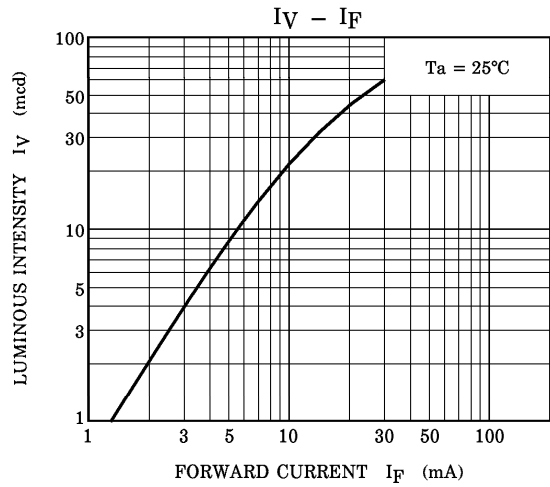
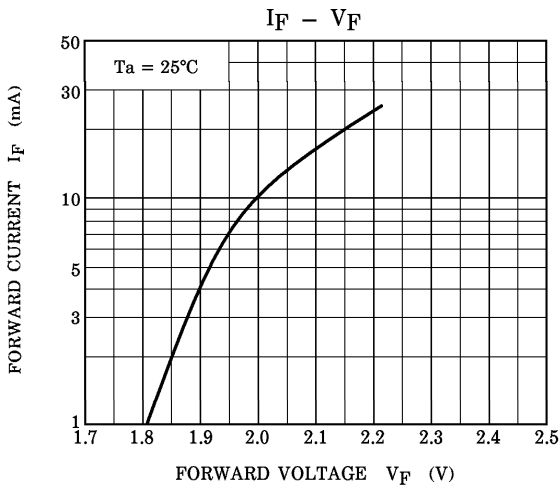
PRODUCT NAME	FORWARD VOLTAGE $V_F$				REVERSE CURRENT $I_R$	
	MIN	TYP.	MAX	$I_F$	MAX	$V_R$
TLS1005A	—	2.05	2.6	20	50	4
TLG1005A	—	2.15	2.5	20	5	4
TLPG1005A	—	2.15	2.6	20	5	4
Unit	V			mA	$\mu$ A	V

OPTICAL CHARACTERISTICS (Ta = 25°C)

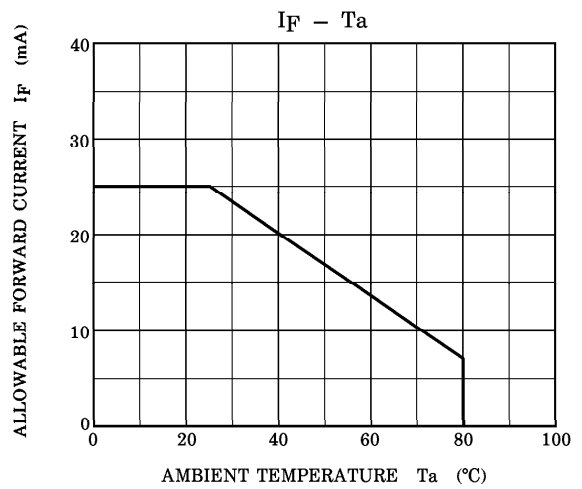
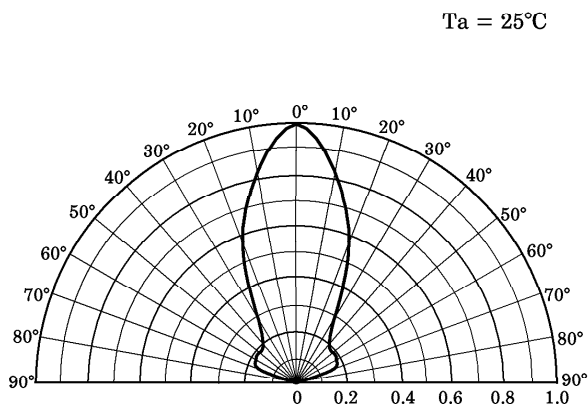
PRODUCT NAME	LUMINOUS INTENSITY $I_v$			
	MIN	TYP.	MAX	$I_F$
TLS1005A	8.5	25	—	20
TLG1005A	15.3	45	—	20
TLPG1005A	4.76	12	—	20
Unit	mcd			mA

PRODUCT NAME	EMISSION SPECTRUM				
	Peak Emission Wavelength $\lambda_p$			$\Delta\lambda$	$I_F$
	MIN	TYP.	MAX		
TLS1005A	—	635	—	40	20
TLG1005A	—	567	—	25	20
TLPG1005A	—	555	—	20	20
Unit	nm			nm	mA

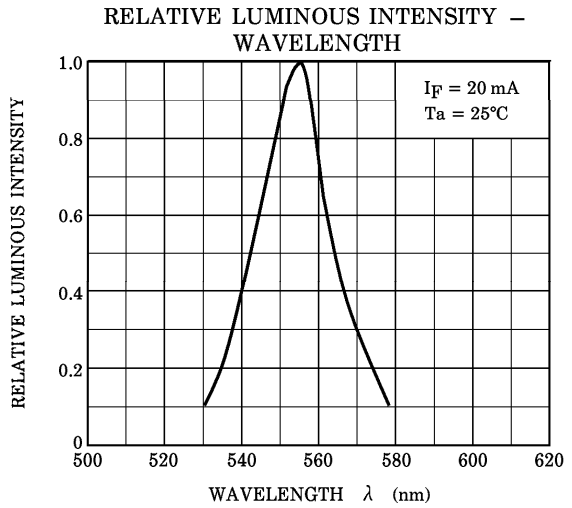
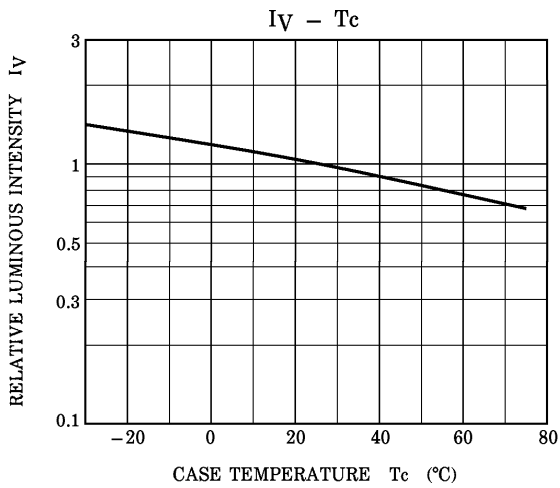
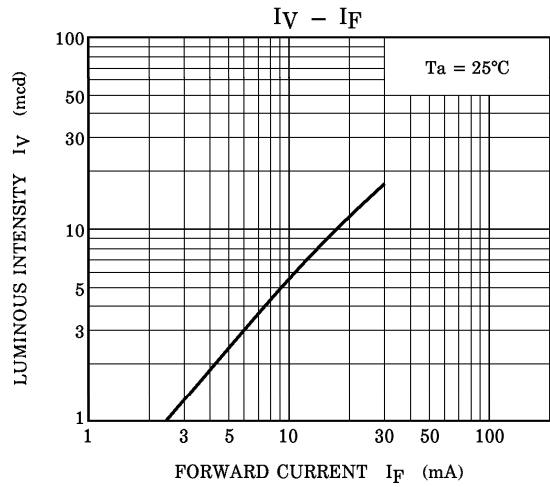
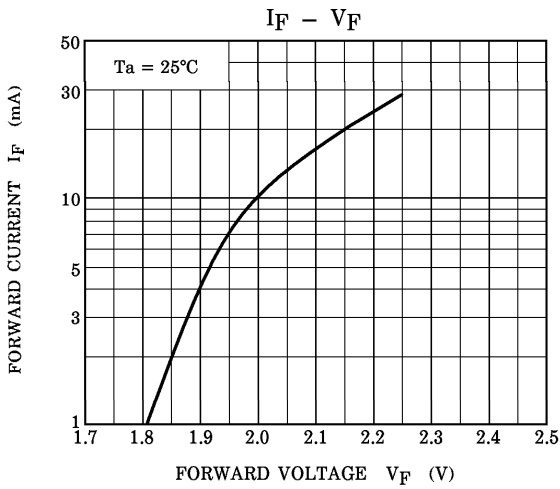
**TLG1005A**



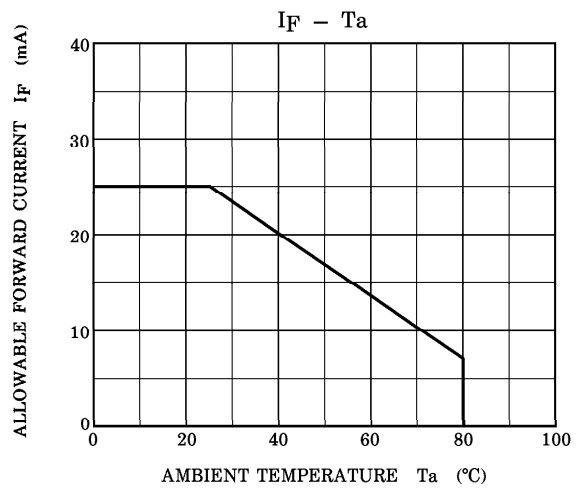
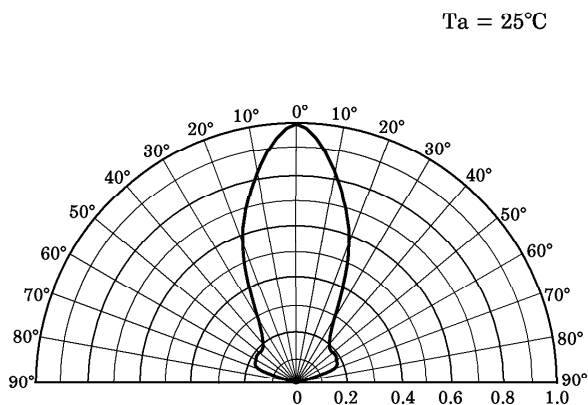
**RADIATION PATTERN**



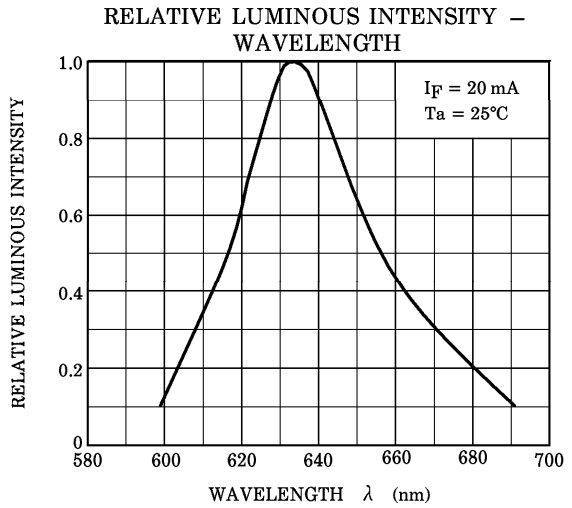
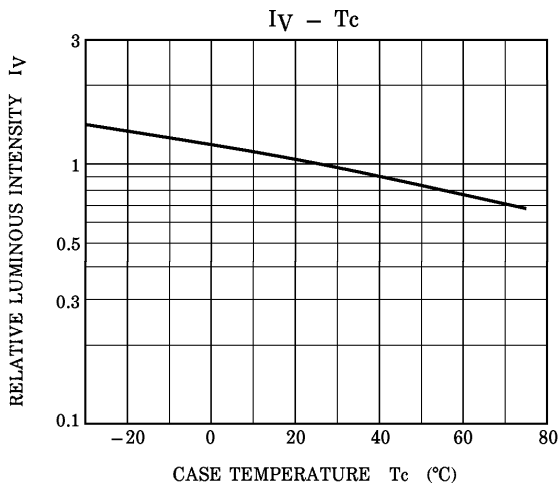
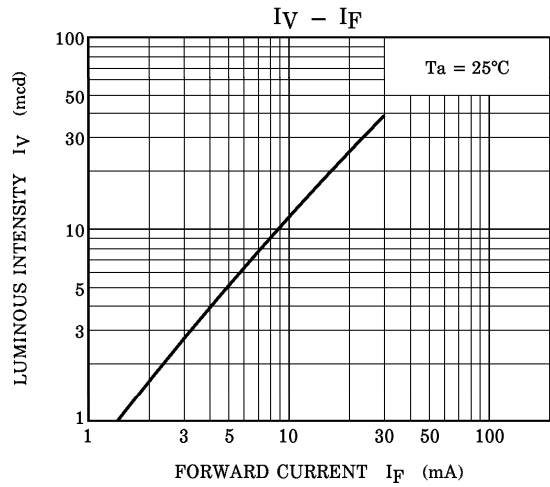
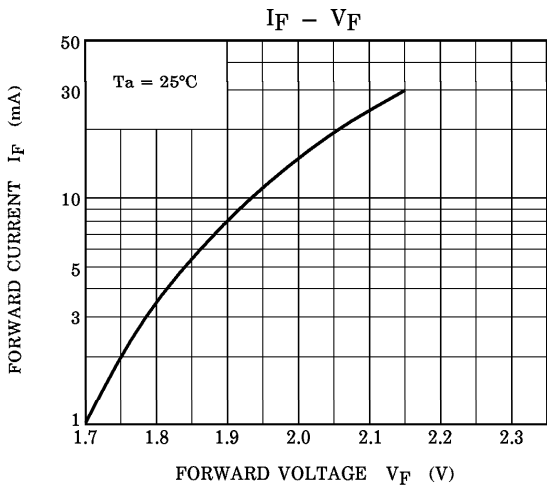
**TLPG1005A**



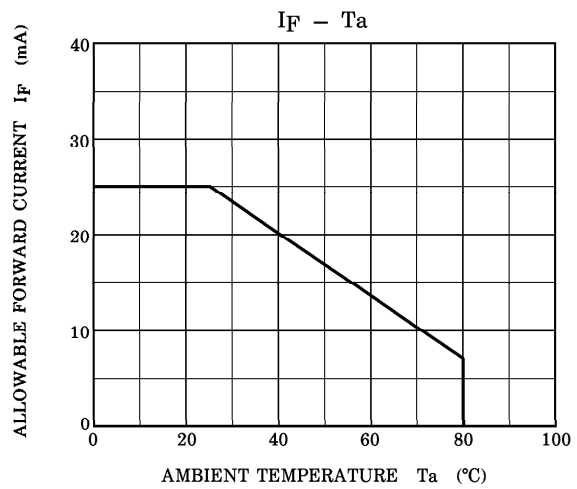
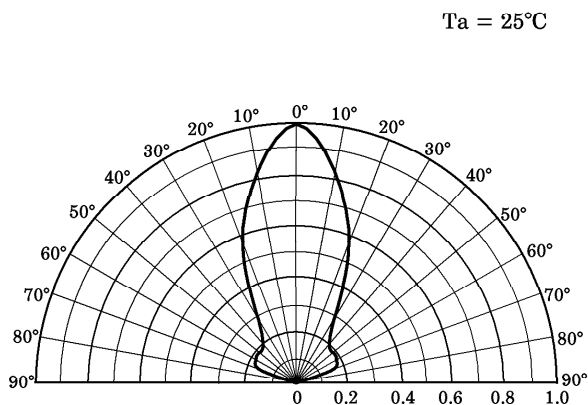
**RADIATION PATTERN**



**TLS1005A**



**RADIATION PATTERN**



**PACKAGING**

This LED device is packed in an aluminum envelope with silica gel to avoid moisture absorption. The optical characteristics may be affected by exposure to moisture in the air prior to soldering and it should be stored under the following conditions.

- Temperature : 5~30°C
- Relative Humidity : 60% or lower

Baking is required if the device have been stored unopened for more than 6 months or if the aluminum envelope has been opened for more than 168 h.

Recommended baking condition is 60°C for 12 h minimum in the dry atmosphere.

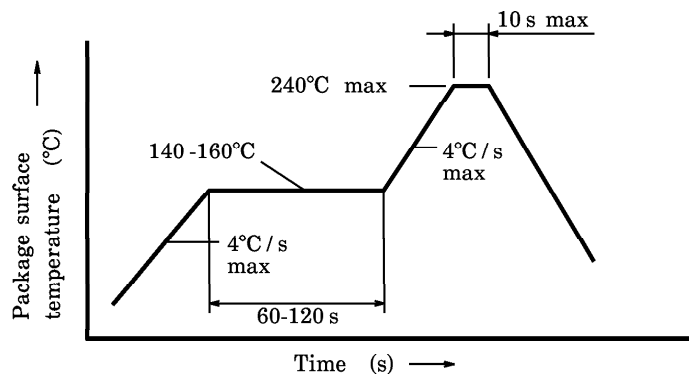
**PRECAUTION FOR MOUNTING**

- Do not apply force to the plastic part of the LED in high temperature conditions.
- Do not apply friction using a hard materials for avoid injuring the plastic part of the LED.
- Keep the LED away from any other parts when assembling boards into the set.

**SOLDERING**

- Reflow soldering

Temperature profile

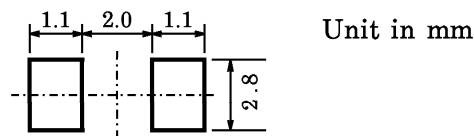


- Second time reflow

In case of second reflow soldering, it should be performed within 168 h after first reflow under the above conditions.

Storage conditions before second reflow soldering : 30°C, 60% RH or lower

- Do not perform flow soldering.
- Recommended soldering pattern



- Make any necessary soldering corrections manually.  
(Do not do this more than once for any given pin.)

- Soldering iron : Less than 25 W
- Temperature : Lower than 300°C
- Time : Within 3 s

**POST SOLDER CLEANING**

When cleaning after soldering is needed, the following condition must be adhered to.

Cleaning solvents : AK225 or Alcohol  
Temperature : 50°C (max) for 30 s (max) or 30°C (max) for 3 minutes (max)  
Ultrasonic : 300 W max

**AUTOMATIC MOUNTING : RECOMMENDED CONDITION**

Absorption Head Diameter	$\phi 1.2$ mm
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Please ask the mounting equipment maker for the ideal automatic mounting condition.

**TAPING SPECIFICATIONS**

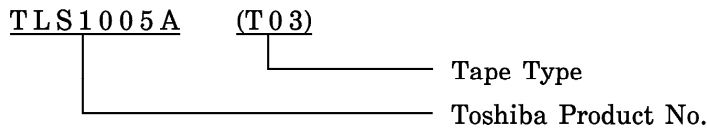
This specification lays out the 4 mm pitch embossed-tape packing requirements for 3.2 mm (L) × 2.4 mm (W) × 2.4 mm (H) size surface-mount LED lamp.

**1. Product Naming System**

The type of package used for shipment is denoted by a symbol suffix after the product number. The method of classification is as below. (this method, however does not apply to products whose electrical characteristics differ from standard Toshiba specifications)

(1) Tape Type : T03 (4 mm pitch)

(2) Example

**2. Related Matter**

(1) Electro-optical Characteristics

Please refer to the each technical datasheet for electro-optical characteristics of tape packed products

(2) Handling Precautions

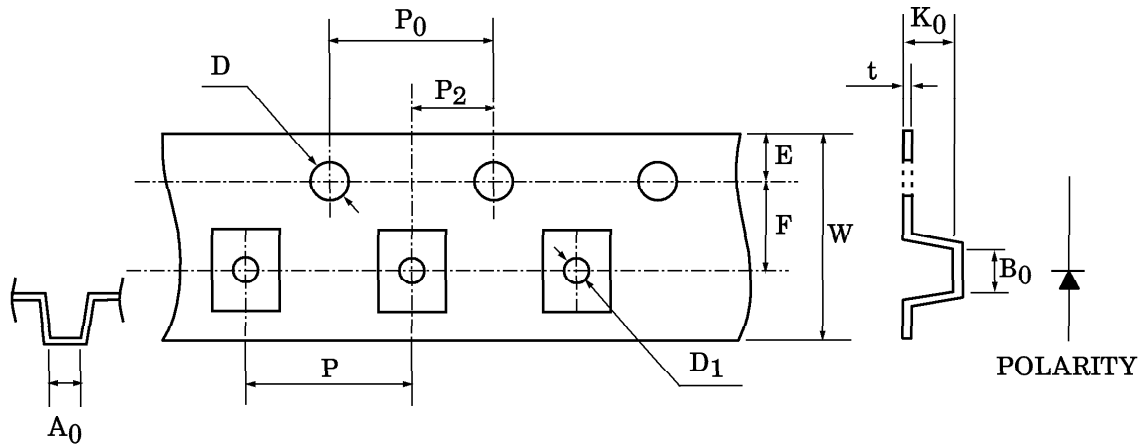
Tape material protected against static electricity. However, static electricity may occur depending on quantity of charged static electricity and a device may attach to a tape, or a device may be unstable when peeling a tape cover.

- a) In process, taping materials may sustain an electrostatic charge, use an ionizer to neutralize the ions.
- b) For transport and temporary storage of devices, use containers (boxes, jigs, bags) that are made of anti-static materials or of materials that dissipate electrostatic electricity.

3. Dimensions of tape

(Unit in mm)

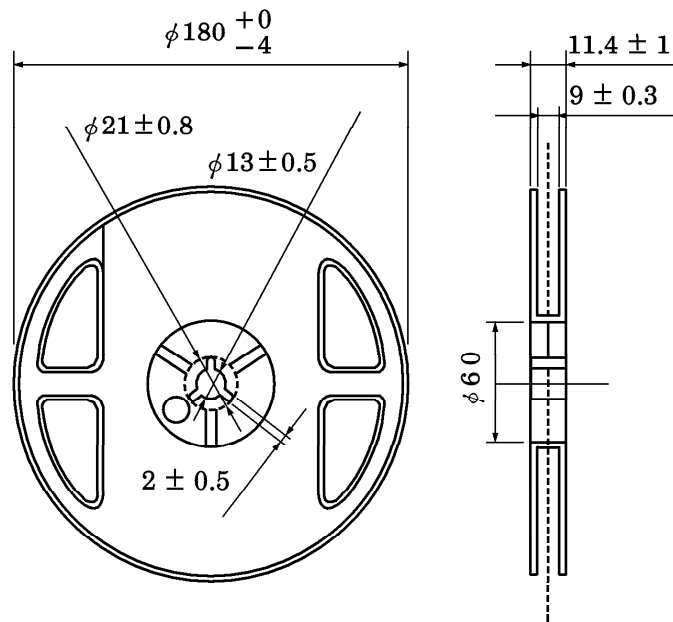
SYMBOL	DIMENSION	TOLERANCE	SYMBOL	DIMENSION	TOLERANCE
D	1.50	+0.1 / -0	P <sub>2</sub>	2.00	±0.05
E	1.75	±0.1	W	8.00	±0.3
P <sub>0</sub>	4.00	±0.1	P	4.00	±0.1
t	0.25	±0.05	A <sub>0</sub>	2.80	±0.1
F	3.50	±0.05	B <sub>0</sub>	3.50	±0.1
D <sub>1</sub>	1.10	±0.1	K <sub>0</sub>	2.70	±0.1



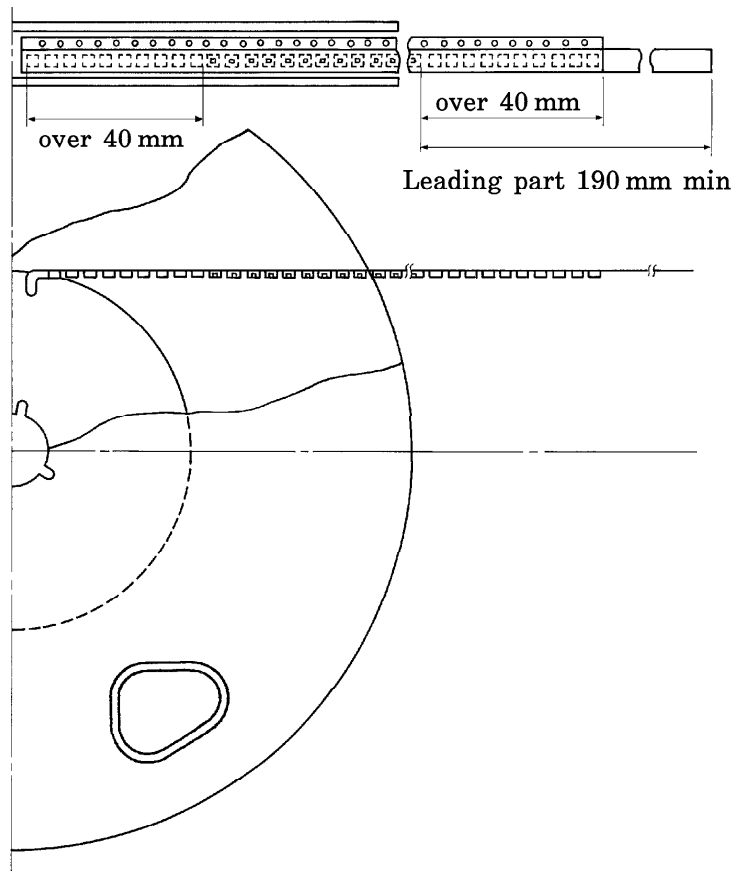


4. Dimensions of reel

Unit in mm



5. Leading part



6. Packing Form

(1) Number of Devices per Reel and Carton

Reel	1000 devices
Carton	5000 devices

(2) Packing : Silica gel and reel are packed into sealed aluminum pack.

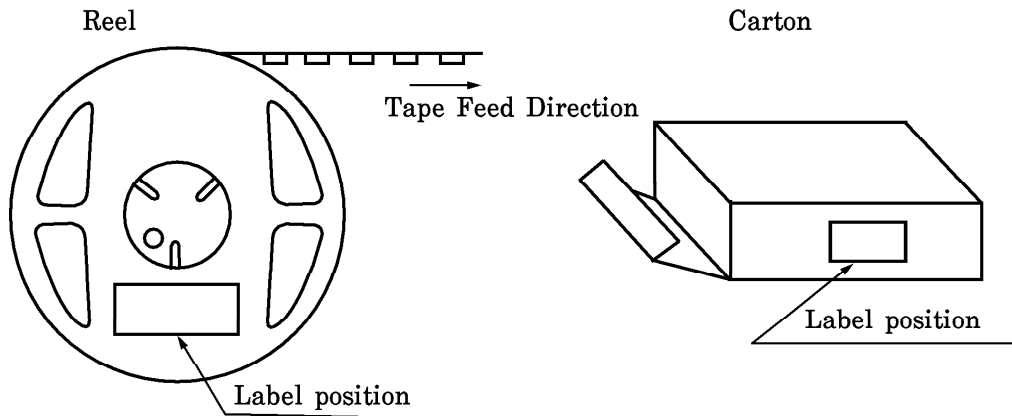
7. Notation Method

(1) Example : TLS1005A (T03)

P/N :

TYPE	TLS1005A		
ADD. C	(T03)	Q'TY	1000 pcs
NOTE	(rank symbol)		Lot Number

(2) Label location :



Aluminum pack : Attached to center of one side